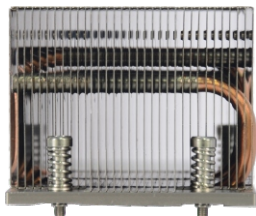


## AMD SP3 Series 200W 2U Server CPU Cooler SF4P2U-0001-A01



### Features :

- Best-In-Class Thermal Performance: CPU Temperatures below 57°C @ 25°C Ambient**  
 Cooltron's Heat Sink Only Designs of Four Ø6mm Heat Pipes and Zipped Stamping Fin Stack accelerate up to 200W heat vortex dissipation, and patented Flat & Tight-fitting Heat Pipes embedding & engaging technologies enable to reduce the total thermal resistance to the minimum that help drop CPU temperatures instantly to avoid any overheated CPU breakdown
- Comprehensive AMD CPU Compatibility**  
 Supports AMD SP3 Socket Compatible CPUs - AMD Zen- and AMD Zen 2-based Epyc Server Processors
- Easy & Flexible Installation**  
 Cooltron's complete CPU Cooler package including mounting system and thermal paste ensures easy and quick installation. It's also flexible for user to install the CPU Cooler from any angles.

AMD SP3 Series

### CPU Temperature Rise:

Server Size	CPU Socket	TDP (W)	Air Flow (CFM)	Static Pres. (mm-H2O)	Ambient Temperature Ta (°C)	Inlet Temperature (°C)	Outlet Temperature (°C)	CPU Temperature Tc(°C)	Temperature Rise ΔT (°C)	Thermal Resistance (°C/W)
2U	AMD SP3 ILM	200	19.98	2.59	25.00	24.90	40.70	56.60	31.70	0.159
		200	24.91	3.54	25.00	25.30	38.50	54.20	28.90	0.145
		200	30.07	4.67	25.00	24.80	35.90	51.70	26.90	0.135
		200	35.13	5.90	25.00	25.30	34.70	50.60	25.30	0.127
		200	40.02	7.25	25.00	23.30	31.60	47.50	24.20	0.121

### Product Information:

Model Number:	SF4P2U-0001-A01
TDP (W):	200W
Compatible CPU Socket:	AMD SP3 ILM
Application:	2U Server and Up (Passive)
Dimension (mm):	120.0 x 80.0 x 63.5
Heat Sinks:	AL Base + Cu Block +AL Fin + Heatpipe(Ø 6mm x 4)

Applications: Data-Center, Rack & Tower Servers, High Speed Computing

P-Q-Tc Curve:

